FAIRCHILD

SEMICONDUCTOR®

SSP7N60B/SSS7N60B

600V N-Channel MOSFET

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supplies.

Features

- 7.0A, 600V, $R_{DS(on)} = 1.2\Omega @V_{GS} = 10 V$ Low gate charge (typical 38 nC)
- Low Crss (typical 23 pF) •
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- TO-220F package isolation = 4.0kV (Note 6)



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

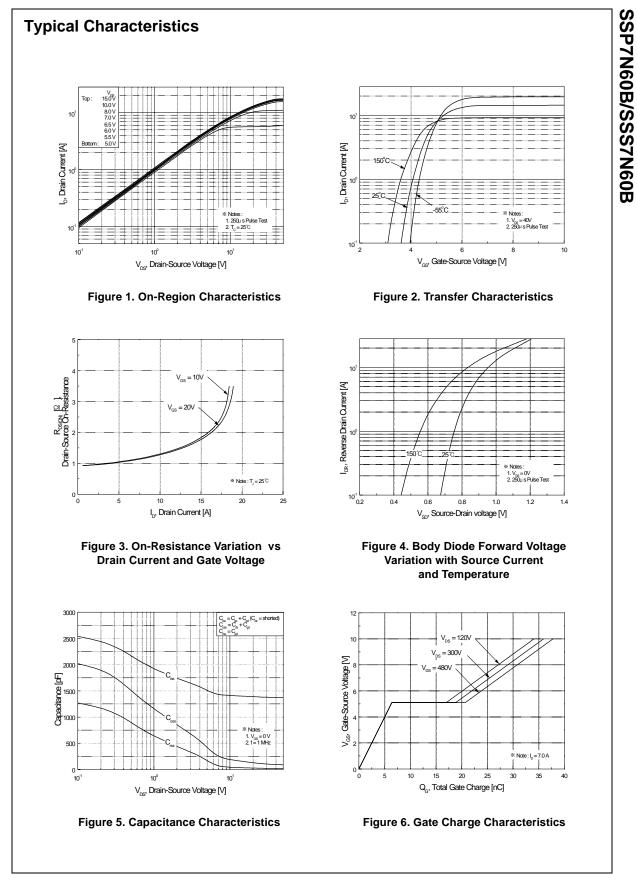
Symbol	Parameter		SSP7N60B	SSS7N60B	Units
V _{DSS}	Drain-Source Voltage		6	00	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		7.0	7.0 *	А
	- Continuous (T _C = 100°C)		4.4	4.4 *	А
I _{DM}	Drain Current - Pulsed	(Note 1)	28	28 *	А
V _{GSS}	Gate-Source Voltage		± 30		V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		420		mJ
I _{AR}	Avalanche Current	(Note 1)	7.0		А
E _{AR}	Repetitive Avalanche Energy (Note 1)		14.7		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		5.5		V/ns
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C		147	48	W
			1.18	0.38	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to	o +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300		°C
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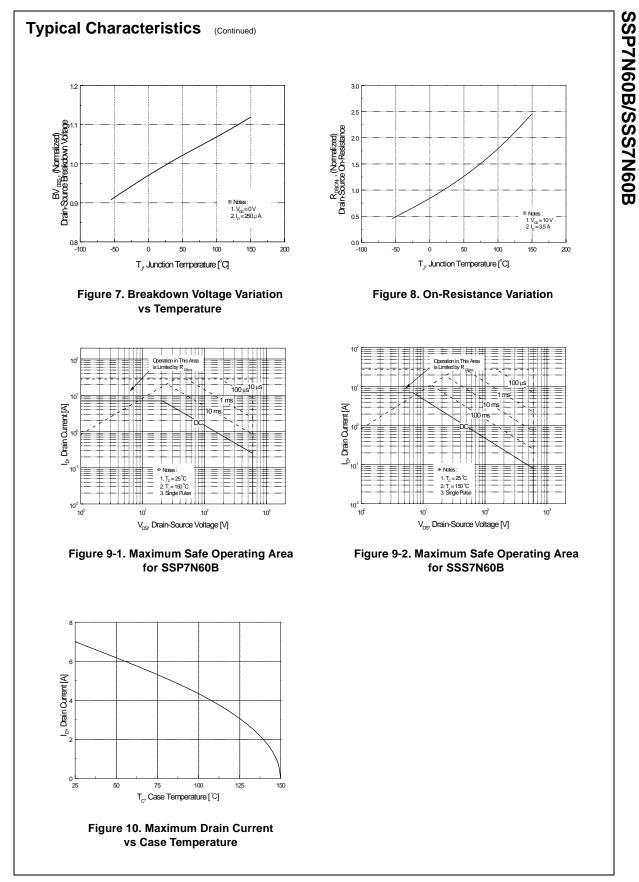
Thermal Characteristics

Symbol	Parameter	SSP7N60B	SSS7N60B	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case Max.	0.85	2.6	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ.			°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient Max.	62.5	62.5	°C/W

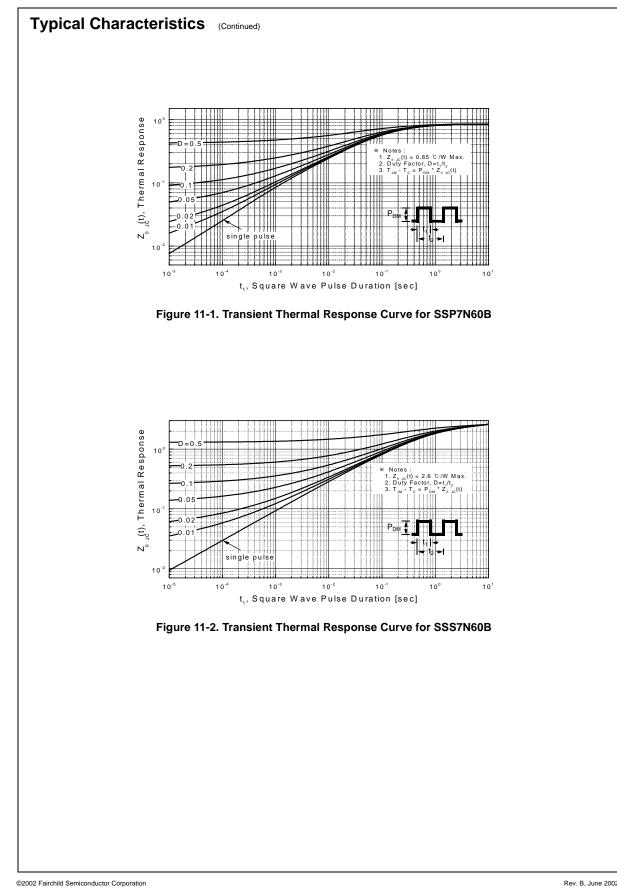
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
	restoriction					
BV _{DSS}	Iracteristics Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	600			V
ΔBV_{DSS} / ΔT_{1}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		0.65		V/°C
I _{DSS}		V _{DS} = 600 V, V _{GS} = 0 V			10	μA
·D22	Zero Gate Voltage Drain Current	$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			100	μ <u>Α</u>
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-100	nA
0001		00 00				
	racteristics		1			
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V_{GS} = 10 V, I _D = 3.5 A		1.0	1.2	Ω
9fs	Forward Transconductance	$V_{DS} = 40 \text{ V}, I_D = 3.5 \text{ A}$ (Note 4)		8.2		S
Dynami	ic Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		1380	1800	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		115	150	pF
C _{rss}	Reverse Transfer Capacitance	-		23	30	pF
Switchi	ng Characteristics					
t _{d(on)}	Turn-On Delay Time			30	70	ns
t _r	Turn-On Rise Time	$V_{DD} = 300 \text{ V}, I_D = 7.0 \text{ A},$		80	170	ns
t _{d(off)}	Turn-Off Delay Time	$R_{G} = 25 \Omega$		125	260	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		85	180	ns
Q _g	Total Gate Charge	V _{DS} = 480 V, I _D = 7.0 A,		38	50	nC
Q _{gs}	Gate-Source Charge	$V_{\rm GS} = 400$ V, $I_{\rm D} = 7.0$ A, $V_{\rm GS} = 10$ V		6.4		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		15		nC
Drain-S I _S I _{SM}	Maximum Continuous Drain-Source Diode Forward Current Maximum Pulsed Drain-Source Diode Forward Current				7.0 28	A
V _{SD}	Drain-Source Diode Forward Voltage				1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 7.0 A,$		415		ns
		$dI_{\rm F} / dt = 100 \text{ A}/\mu \text{s} \qquad (\text{Note 4})$				-
Q_{rr} otes: Repetitive F L = 15.7mH I _{SD} \leq 7.0A, Pulse Test : Essentially i	$\label{eq:response} \begin{array}{l} \label{eq:response} \end{tabular} \\ \mbox{Retring: Pulse width limited by maximum junction tempe} \\ \mbox{I}_{AS} = 7.0A, \ V_{DD} = 50V, \ R_G = 25 \ \Omega, \ Starting \ T_J = 25^{\circ}C \\ \mbox{di/dt} \leq 300 \mbox{/}\mus, \ V_{DD} \leq BV_{DSS}, \ Starting \ T_J = 25^{\circ}C \\ \mbox{Pulse width} \leq 300 \mbox{/}\mus, \ Duty \ cycle \leq 2\% \\ \mbox{independent of operating temperature} \\ \mbox{s ide in } \ V_{BO} = 4.0 \mbox{V} \ and \ t = 0.3 \mbox{s} \end{array}$	$dI_F / dt = 100 \text{ A}/\mu \text{s}$ (Note 4)		4.6		μC

SSP7N60B/SSS7N60B





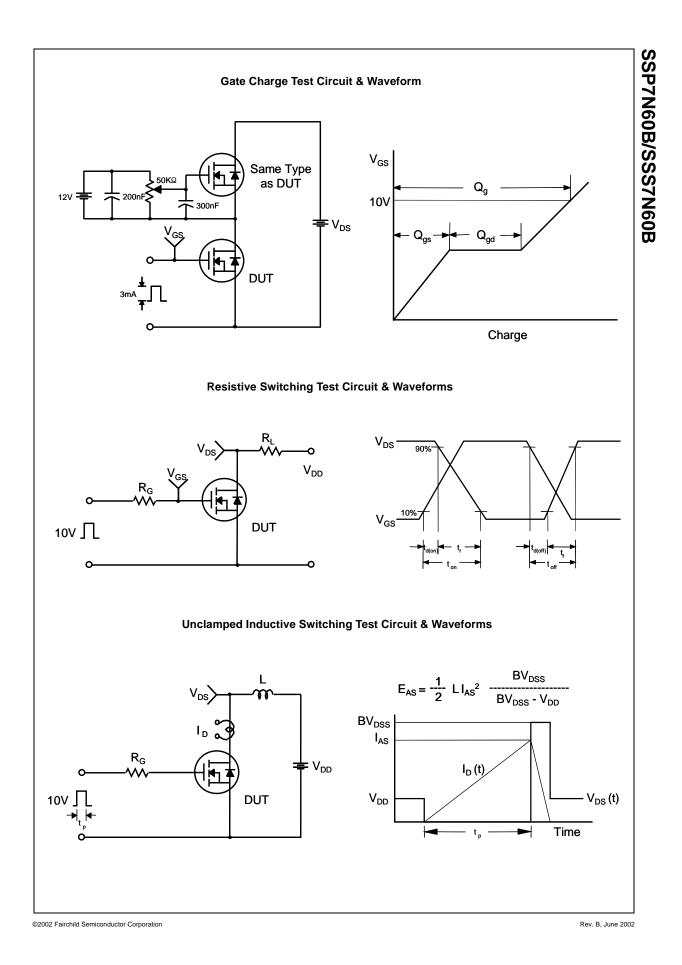
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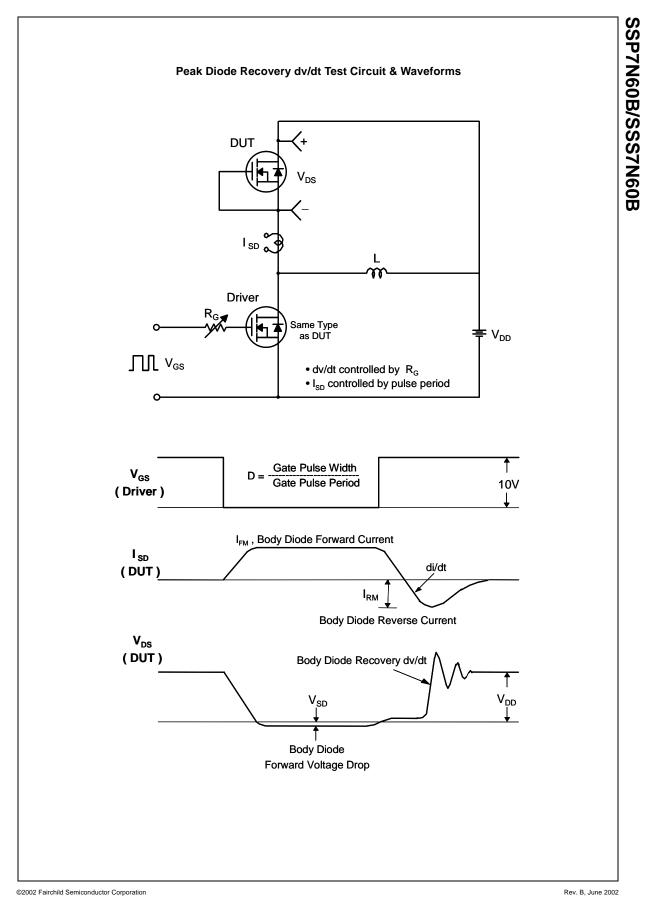
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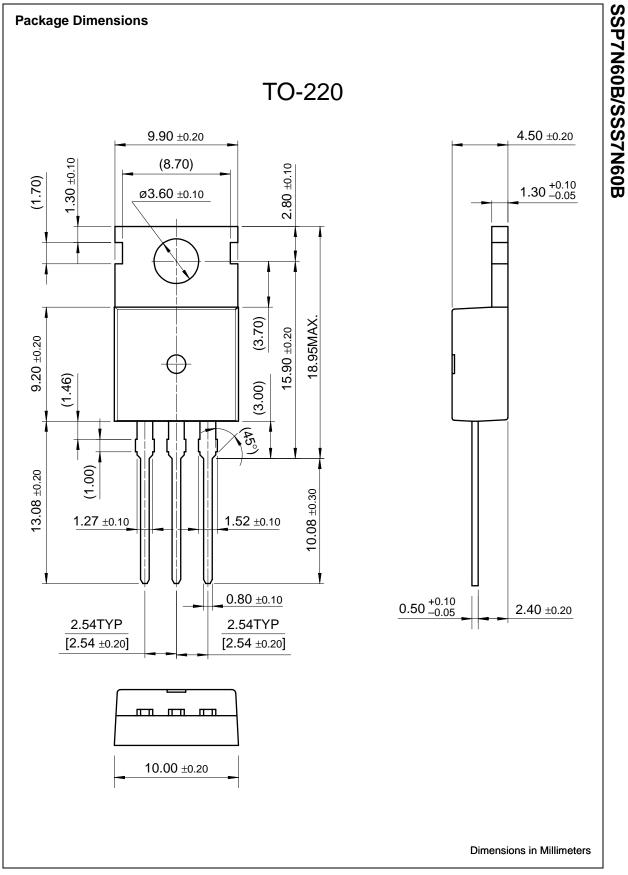
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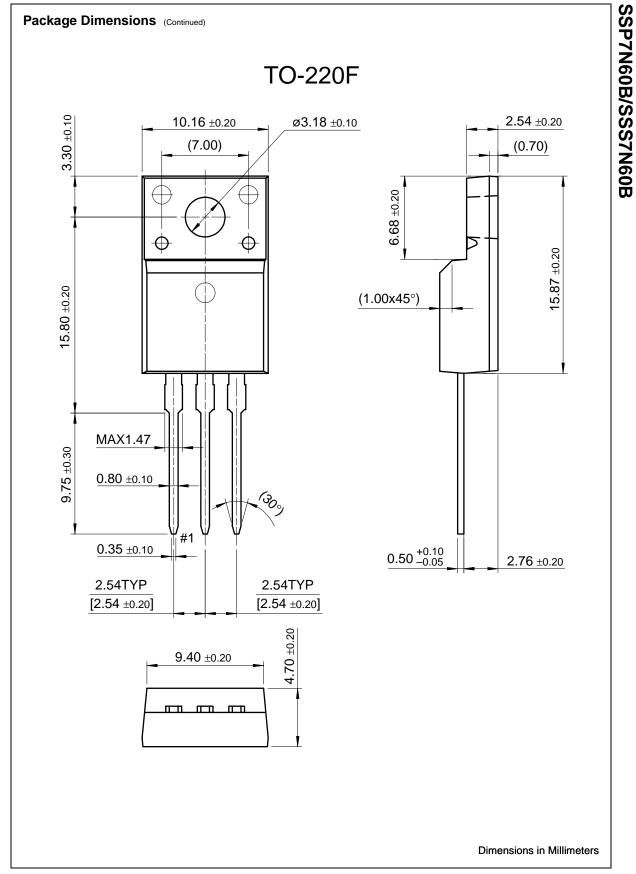
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